

## AN32058A

http://www.semicon.panasonic.co.jp/en/

## 7 x 7 Dots Matrix LED Driver LSI

### FEATURES

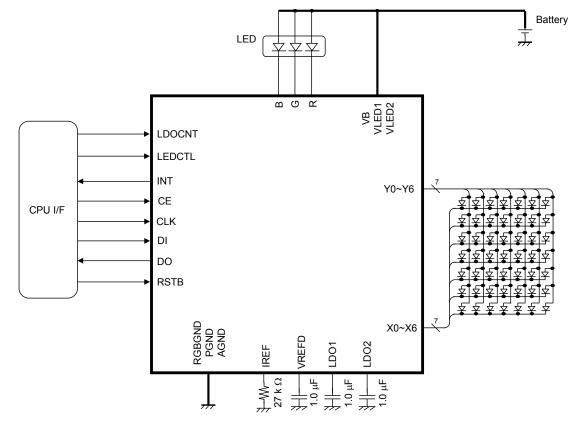
- 7 x 7 LED Matrix Driver
  - (Total LED that can be driven = 49)
- Built-in memory (ROM and RAM)
- LDO : 2-ch
- SPI Interface : 1-ch
- Driver for RGB color unit : 1-ch
- 44 pin Plastic Quad Flat Non-leaded package (QFN Type)

#### DESCRIPTION

AN32058A is 49 Dots Matrix LED Driver. It can drive up to 16 RGB LEDs.

#### **APPLICATIONS**

- Mobile Phone
- Smart Phone
- PCs
- Game Consoles
- Home Appliances etc.



## TYPICAL APPLICATION

#### Note)

The application circuit is an example. The operation of the mass production set is not guaranteed. Sufficient evaluation and verification is required in the design of the mass production set. The Customer is fully responsible for the incorporation of the above illustrated application circuit in the design of the equipment.



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## ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit	Note
Cupply voltage	VB <sub>MAX</sub>	6.0	V	*1
Supply voltage	VLED <sub>MAX</sub>	6.5	V	*1
Operating ambience temperature	T <sub>opr</sub>	– 30 to + 85	°C	*2
Operating junction temperature	Tj	– 30 to + 125	°C	*2
Storage temperature	T <sub>stg</sub>	– 55 to + 125	°C	*2
Input Voltage Range	LEDCTL, RSTB, CE, CLK, DI	– 0.3 to 3.4	V	_
	LDOCNT	– 0.3 to 6.0	V	—
	INT, DO	– 0.3 to 3.4	V	—
Output Voltage Range	R, G, B, LDO1, LDO2, X0, X1, X2, X3, X4, X5, X6, Y0, Y1, Y2, Y3, Y4, Y5, Y6	– 0.3 to 6.5	V	_
ESD	HBM (Human Body Model)	2.0	kV	—

Note) This product may sustain permanent damage if subjected to conditions higher than the above stated absolute maximum rating. This rating is the maximum rating and device operating at this range is not guaranteeable as it is higher than our stated recommended operating range.

When subjected under the absolute maximum rating for a long time, the reliability of the product may be affected.

\*1  $VB_{MAX} = VB$ ,  $VLED_{MAX} = VLED1 = VLED2$ .

The values under the condition not exceeding the above absolute maximum ratings and the power dissipation.

\*2 Except for the power dissipation, operating ambient temperature, and storage temperature, all ratings are for Ta = 25°C.

## **POWER DISSIPATION RATING**

PACKAGE	$\theta_{JA}$	P <sub>D</sub> (Ta=25 °C)	Р <sub>D</sub> (Та=85 °С)
44 pin Plastic Quad Flat Non-leaded package (QFN Type)	71.8 °C /W	1.392 W	0.557 W

Note) For the actual usage, please refer to the P<sub>D</sub>-Ta characteristics diagram in the package specification, follow the power supply voltage, load and ambient temperature conditions to ensure that there is enough margin and the thermal design does not exceed the allowable value.



### CAUTION

Although this IC has built-in ESD protection circuit, it may still sustain permanent damage if not handled properly. Therefore, proper ESD precautions are recommended to avoid electrostatic damage to the MOS gates

## **RECOMMENDED OPERATING CONDITIONS**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Note
Supply voltage range	VB	3.1	3.7	4.6	V	*1
Supply voltage range	VLED	3.1	5.0	5.6	V	*1
Input Voltage Range	LEDCTL, RSTB, CE, CLK, DI	- 0.3	_	3.0	V	_
	LDOCNT	- 0.3		VB + 0.3	V	*2
	INT, DO	- 0.3	—	3.0	V	_
Output Voltage Range	R, G, B, LDO1, LDO2, X0, X1, X2, X3, X4, X5, X6, Y0, Y1, Y2, Y3, Y4, Y5, Y6	- 0.3		VLED + 0.3	V	*2

Note) \*1: The values under the condition not exceeding the above absolute maximum ratings and the power dissipation. Do not apply external currents and voltages to any pin not specifically mentioned. Voltage values, unless otherwise specified, are with respect to GND. GND is voltage for AGND, RGBGND and PGND. VB is voltage for VB. VLED is voltage for VLED1 and VLED2.

\*2: (VB + 0.3) V must not exceed 6 V. (VLED + 0.3) V must not exceed 6.5 V.

## **ELECTRICAL CHARACTERISTICS**

VB = 3.6 V, VLED1 = VLED2 = 4.9 V

Note) T<sub>a</sub> = 25 °C  $\pm$  2 °C unless otherwise specified.

	Devementer	Symbol	Condition		Limits		Unit	Note
	Parameter	Symbol	Condition	Min	Тур	Max	Unit	Note
Cu	rrent consumption							
	Current consumption (1)	ICC1	At OFF mode LDOCNT = Low	_	0	1	μA	_
	Current consumption (2)	ICC2	At Standby mode LDOCNT = Low LDO2 is active.		8	12	μA	
	Current consumption (3)	ICC3	LDOCNT = High LDO1 and LDO2 are active.	_	18	24	μA	
Reference voltage								
	Output voltage	VREF	I <sub>VREF</sub> = 0 μA	1.21	1.24	1.27	V	_
Re	ference current							
	Output voltage	VIREF	I <sub>IREF</sub> = 0 μA	0.44	0.54	0.64	V	_
Vo	Itage regulator (LDO1)							
	Output voltage	VL1	I <sub>LDO1</sub> = – 30 mA	1.79	1.85	1.91	V	_
	Short circuit protection current	IPT1	LDOCNT = High REG18 = High V <sub>LDO1</sub> = 0 V, IPT1 = I <sub>LDO1</sub>	50	100	200	mA	
	Ripple rejection (1)	PSL11	VB = $3.6$ V + $0.2$ V[p-p] f = 1 kHz I <sub>LDO1</sub> = $-15$ mA PSL11 = 20log (acV <sub>LDO1</sub> / $0.2$ )	_	- 45	- 40	dB	
	Ripple rejection (2)	PSL12	VB = $3.6 V + 0.2 V[p-p]$ f = $10 kHz$ I <sub>LDO1</sub> = $-15 mA$ PSL12 = $20log (acV_{LDO1} / 0.2)$		- 35	- 25	dB	

## ELECTRICAL CHARACTERISTICS (continued)

VB = 3.6 V, VLED1 = VLED2 = 4.9 V

Note)  $T_a = 25 \ ^\circ C \pm 2 \ ^\circ C$  unless otherwise specified.

	Parameter	Symbol	Condition		Limits		Unit	Note
	Parameter	Symbol	Condition	Min	Тур	Мах	Unit	Note
Vo	Itage regulator (LDO2)							
	Output voltage	VL2	I <sub>LDO2</sub> = – 30 mA	2.76	2.85	2.94	V	_
	Short circuit protection current	IPT2	LDOCNT = High $V_{LDO2} = 0V$ IPT2 = I <sub>LDO2</sub>	50	100	300	mA	_
	Ripple rejection (1)	PSL21	VB = $3.6 V + 0.2 V[p-p]$ f = 1 kHz I <sub>LDO2</sub> = $-15 mA$ PSL21 = 20log (acV <sub>LDO2</sub> / 0.2)	_	- 35	- 30	dB	
	Ripple rejection (2)	PSL22	VB = 3.6 V + 0.2 V[p-p] f = 10 kHz I <sub>LDO2</sub> = – 15 mA PSL22 = 20log (acV <sub>LDO2</sub> / 0.2)	_	- 25	- 15	dB	
Os	cillator							
	Oscillation frequency	FDC	_	0.96	1.20	1.44	MHz	_
sc	CAN Switch							
	Resistance at the Switch ON	RSCAN	I <sub>Y0, Y1, Y2, Y3, Y4, Y5, Y6</sub> = 5 mA RSCAN = V <sub>Y0, Y1, Y2, Y3, Y4, Y5, Y6</sub> / 5 mA		2	4.8	Ω	

### ELECTRICAL CHARACTERISTICS (continued)

VB = 3.6 V, VLED1 = VLED2 = 4.9 V

Note)  $~~T_a$  = 25  $^{\circ}C$   $\pm$  2  $^{\circ}C$  unless otherwise specified.

	Parameter	Symbol	Condition		Limits		Unit	Note
	Parameter	Symbol	Condition	Min	Тур	Мах	Unit	Note
Cu	rrent generator (For $7 \times 7$ dots	s matrix Ll	ED)					
	Output current (1)	IMX1	At 1mA setup $V_{X0, X1, X2, X3, X4, X5, X6} = 1 V$ IMX1 = I <sub>X0, X1, X2, X3, X4, X5, X6</sub>	0.950	1.033	1.116	mA	*1
	Output current (2)	IMX2	At 2 mA setup V <sub>x0, x1, x2, x3, x4, x5, x6</sub> = 1 V IMX2 = I <sub>x0, x1, x2, x3, x4, x5, x6</sub>	1.907	2.073	2.239	mA	*1
	Output current (3)	IMX4	At 4 mA setup $V_{X0, X1, X2, X3, X4, X5, X6} = 1 V$ IMX4 = I <sub>X0, X1, X2, X3, X4, X5, X6</sub>	3.824	4.157	4.490	mA	*1
	Output current (4)	IMX8	At 8 mA setup V <sub>x0, x1, x2, x3, x4, x5, x6</sub> = 1 V IMX8 = I <sub>x0, x1, x2, x3, x4, x5, x6</sub>	7.660	8.326	8.992	mA	*1
	Output current (5)	IMX15	At 15 mA setup V <sub>x0, x1, x2, x3, x4, x5, x6</sub> = 1 V IMX15 = I <sub>x0, x1, x2, x3, x4, x5, x6</sub>	14.408	15.661	16.914	mA	*1
	Leakage Current when matrix LED turns off	IMXOFF	Current OFF setup V <sub>x0, x1, x2, x3, x4, x5, x6</sub> = 4.75 V IMXOFF = I <sub>x0, x1, x2, x3, x4, x5, x6</sub>			1	μΑ	_
	The error between channels	IMXCH	The average value of all channels, and the current error of each channel	- 5		5	%	_

\*1 : Values when recommended parts (ERJ2RHD273X) are used for IREF terminal. The other current settings are combination of above items.

### ELECTRICAL CHARACTERISTICS (continued)

VB = 3.6 V, VLED1 = VLED2 = 4.9 V

Note)  $T_a = 25 \ ^\circ C \pm 2 \ ^\circ C$  unless otherwise specified.

	Parameter	Symbol	Condition		Limits		Unit	Note
	Farameter	Symbol	Condition	Min	Тур	Max	Unit	Note
Cu	rrent generator (For RGB colo	r unit)						
	Output current (1)	IRGB1	At 1mA setup V <sub>R, G, B</sub> = 1 V	0.949	1.031	1.113	mA	*1
	Output current (2)	IRGB2	At 2 mA setup V <sub>R, G, B</sub> = 1 V	1.892	2.056	2.220	mA	*1
	Output current (3)	IRGB4	At 4 mA setup V <sub>R, G, B</sub> = 1 V	3.764	4.091	4.418	mA	*1
	Output current (4)	IRGB8	At 8 mA setup V <sub>R, G, B</sub> = 1 V	7.510	8.163	8.816	mA	*1
	Leakage Current when RGB turn off	IRGBOFF	Current OFF setup $V_{R, G, B}$ = 4.75 V IRGBOFF = I <sub>R, G, B</sub>			1	μA	
	The error between channels	IRGBCH	The average value of all channels, and the current error of each channel	- 5		5	%	_

\*1 : Values when recommended parts (ERJ2RHD273X) are used for IREF terminal. The other current settings are combination of above items.

## ELECTRICAL CHARACTERISTICS (continued)

VB = 3.6 V, VLED1 = VLED2 = 4.9 V

Note) T<sub>a</sub> = 25 °C  $\pm$  2 °C unless otherwise specified.

	Parameter	Symbol	Condition		Limits		Unit	Note
	Farameter	Symbol	Condition	Min	Тур	Max	Unit	Note
SP	I I/F, LEDCTL, RSTB							
	Input voltage range of High- level	VIH	High-level recognition voltage	LDO1 × 0.8		LDO2 + 0.3	V	_
	Input voltage range of Low- level	VIL	Low-level recognition voltage	- 0.3		0.4	V	
	Input current of High-level	ШΗ	V <sub>LEDCTL, RSTB, CE, CLK, DI</sub> = 1.85 V IIH = I <sub>LEDCTL, RSTB, CE, CLK, DI</sub>	_	0	1	μA	
	Input current of Low-level	IIL	$V_{LEDCTL, RSTB, CSB, CLK, DI} = 0 V$ IIL = I <sub>LEDCTL, RSTB, CE, CLK, DI</sub>	_	0	1	μA	
ΙΝΤ	-							
	Output voltage of High-level (1)	VOH1	I <sub>INT</sub> = – 2 mA VDDSEL = LDO2	LDO2 × 0.8			V	
	Output voltage of Low-level (1)	VOL1	I <sub>INT</sub> = 2 mA VDDSEL = LDO2 (I <sub>INT</sub> = 0.5 mA )	_		LDO2 ×0.2 (0.15)	V	_
	Output voltage of High-level (2)	VOH2	I <sub>INT</sub> = – 2 mA VDDSEL = LDO1	LDO1 × 0.8		_	V	_
	Output voltage of Low-level (2)	VOL2	I <sub>INT</sub> = 2 mA VDDSEL = LDO1 (I <sub>INT</sub> = 0.5 mA )		_	LDO1 ×0.3 (0.15)	V	_

## ELECTRICAL CHARACTERISTICS (continued)

VB = 3.6 V, VLED1 = VLED2 = 4.9 V

Note) T<sub>a</sub> = 25 °C  $\pm$  2 °C unless otherwise specified.

	Parameter	Symbol	Condition		Limits		Unit	Note
	Farameter	Symbol		Min	Тур	Max	Unit	Note
LD	OCNT							
	Input voltage range of High-level	VIH	High-level recognition voltage	VB × 0.7	_	VB + 0.3	V	
	Input voltage range of Low-level	VIL	Low-level recognition voltage	- 0.3		0.4	V	_
	Input current of High-level	ШН	$V_{LDOCNT} = 3.6 V$ IIH = I <sub>LDOCNT</sub>		0	1	μA	
	Input current of Low-level	IIL	$V_{LDOCNT} = 0 V$ IIL = I <sub>LDOCNT</sub>	_	0	1	μA	
DO								
	Output voltage of High-level	VOH	I <sub>DO</sub> = – 2 mA	LDO1 × 0.8			V	
	Output voltage of Low-level	VOL	I <sub>DO</sub> = 2 mA			LDO1 × 0.2	V	

### ELECTRICAL CHARACTERISTICS (continued)

VB = 3.6 V, VLED1 = VLED2 = 4.9 V

Note)  $T_a = 25 \circ C \pm 2 \circ C$  unless otherwise specified.

	Doromotor	Symbol	Condition		Limits		Unit	Note
	Parameter	Symbol		Min	Тур	Max	Unit	Note
Voltage	e regulator (LDO1) Output	capacitor	1 μF, Output capacitor's ESR less t	than 0.	1Ω			
Ris	se time	Tsu1	Time until output voltage reaches to 0 V to 90%		0.25		ms	*2 *3
Fal	ll time	Tsd1	Time until output voltage reaches to 10%	_	5	_	ms	*2 *3
Ma	aximum load current	IOMAX1	_	_	15	_	mA	*3
Loa	ad transient response (1)	Vtr11	$I_{LDO1}$ = – 50 $\mu$ A $\rightarrow$ – 15 mA (1 $\mu$ s)	_	70	_	mV	*3
Loa	ad transient response (2)	Vtr12	$I_{LDO1}$ = – 15 mA $\rightarrow$ – 50 $\mu$ A (1 $\mu$ s)	_	70	_	mV	*3
Voltage	e regulator (LDO2) Output	capacitor	1 μF, Output capacitor's ESR less	than 0.	1Ω			
Ris	se time	Tsu2	Time until output voltage reaches to 0 V to 90%		0.25		ms	*2 *3
Fal	ll time	Tsd2	Time until output voltage reaches to 10%	_	5	_	ms	*2 *3
Ma	aximum load current	IOMAX2	_		15		mA	*3
Loa	ad transient response (1)	Vtr21	$I_{LDO2}$ = – 50 $\mu$ A $\rightarrow$ – 15 mA (1 $\mu$ s)	_	70	_	mV	*3
Loa	ad transient response (2)	Vtr22	$I_{LDO2}$ = – 15 mA $\rightarrow$ – 50 $\mu$ A (1 $\mu$ s)	_	70	_	mV	*3
TSD (T	hermal shutdown circuit)						-	-
Det	tection temperature	Tdet	Temperature which LDO1, LDO2, Constant current circuit, Matrix SW and RGB turns off.		160		°C	*3 *4
Ret	turn temperature	Tsd11	Returning temperature		110		°C	*3 *5

Note) \*2 : Rise time and Fall time are defined as below.

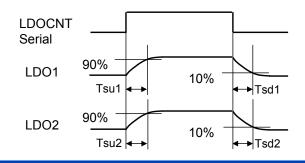
Actual evaluation result of rise time :LDO1 : 290 to 400  $\mu$ s,LDO2 : 220 to 310  $\mu$ sActual evaluation result of fall time :LDO1 : 6.2 to 8.5 ms,LDO2 : 5.8 to 7.9 ms\*2 : Turined Design Volue

\*3 : Typical Design Value

\*4 : LDO1, LDO2, Constant current circuit, and Matrix SW and RGB are turned off when TSD is High.

When TSD is High, the register is set as 14hD1 = 1. However, data can be read only when the register is read immediately after INT occurs since internal regulator is turned off.

\*5 : Only LDO1 and LDO2 return after ON state of TSD. A logic part will be in Reset state.



### ELECTRICAL CHARACTERISTICS (continued)

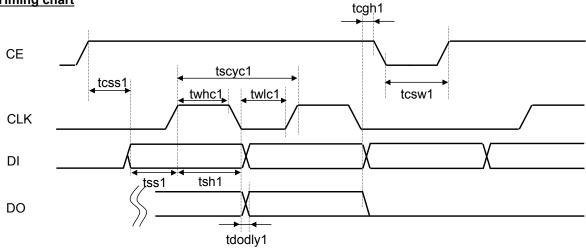
VB = 3.6 V, VLED1 = VLED2 = 4.9 V

Note) T<sub>a</sub> = 25 °C  $\pm$  2 °C unless otherwise specified.

Parameter	Symbol	Condition		Limits		Unit	Note
Parameter	Symbol	Condition	Min	Тур	Мах	Unit	Note
Microcomputer interface characteri	stic (Vdd =	= 1.85 V $\pm$ 3 %) Write ad	ccess Ti	ming			
CLK cycle time	tscyc1	—	—	125	—	ns	*3
CLK cycle time High period	twhc1		_	60	_	ns	*3
CLK cycle time Low period	twlc1		_	60		ns	*3
Serial-data setup time	tss1		_	62		ns	*3
Serial-data hold time	tsh1		_	62		ns	*3
Transceiver interval	tcsw1		_	62		ns	*3
Chip enable setup time	tcss1		_	5		ns	*3
Chip enable hold time	tcgh1	_	_	5	_	ns	*3
Microcomputer interface characteri	stic (Vdd =	1.85 V $\pm$ 3 %) Read ac	ccess Ti	ming			
CLK cycle time	tscyc1	_	_	125	_	ns	*3
CLK cycle time High period	twhc1	_	_	60		ns	*3
CLK cycle time Low period	twlc1		_	60		ns	*3
Serial-data setup time	tss1		_	62		ns	*3
Serial-data hold time	tsh1		_	62		ns	*3
Transceiver interval	tcsw1		_	62		ns	*3
Chip enable setup time	tcss1		_	5	_	ns	*3
Chip enable hold time	tcgh1			5		ns	*3
DC delay time	tdodly1	Only read mode		25		ns	*3

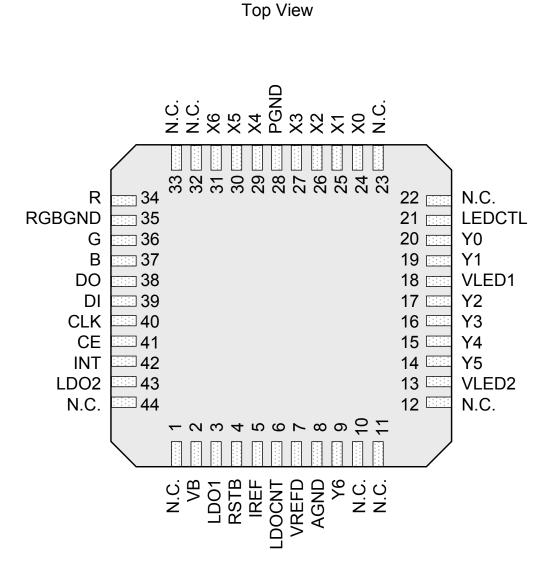
Note) \*3 : Typical Design Value

#### Timing chart





## **PIN CONFIGURATION**





## **PIN FUNCTIONS**

Pin No.	Pin name	Туре	Description
1 10 11 12 22 23 32 33 44	N.C.		No Connection
2	VB	Power supply	The power supply's connect terminal for BGR circuit and LDO circuit.
3	LDO1	Output	LDO1(1.85 V)output terminal.
4	RSTB	Input	Reset input terminal ("L" active )
5	IREF	Output	The resistance connect terminal for constant current value setup.
6	LDOCNT	Input	ON/OFF control terminal of LDO1 and LDO2.
7	VREFD	Output	BGR circuit output terminal.
8	AGND	Ground	The GND terminal for Analog circuitry.
9	Y6	Output	The output terminal of matrix switching control. It connects with the G Column of matrix LED.
13 18	VLED2 VLED1	Power supply	The power supply's connect terminal for matrix LED. Connect with the output of battery or step-up DC/DC converter
14	Y5	Output	The output terminal of matrix switching control. It connects with the F Column of matrix LED.
15	Y4	Output	The output terminal of matrix switching control. It connects with the E Column of matrix LED.
16	Y3	Output	The output terminal of matrix switching control. It connects with the D Column of matrix LED.
17	Y2	Output	The output terminal of matrix switching control. It connects with the C Column of matrix LED.
19	Y1	Output	The output terminal of matrix switching control. It connects with the B Column of matrix LED.
20	Y0	Output	The output terminal of matrix switching control. It connects with the A Column of matrix LED.
21	LEDCTL	Input	LED's lighting ON/OFF control terminal. ( It is based on register 0Ah.)

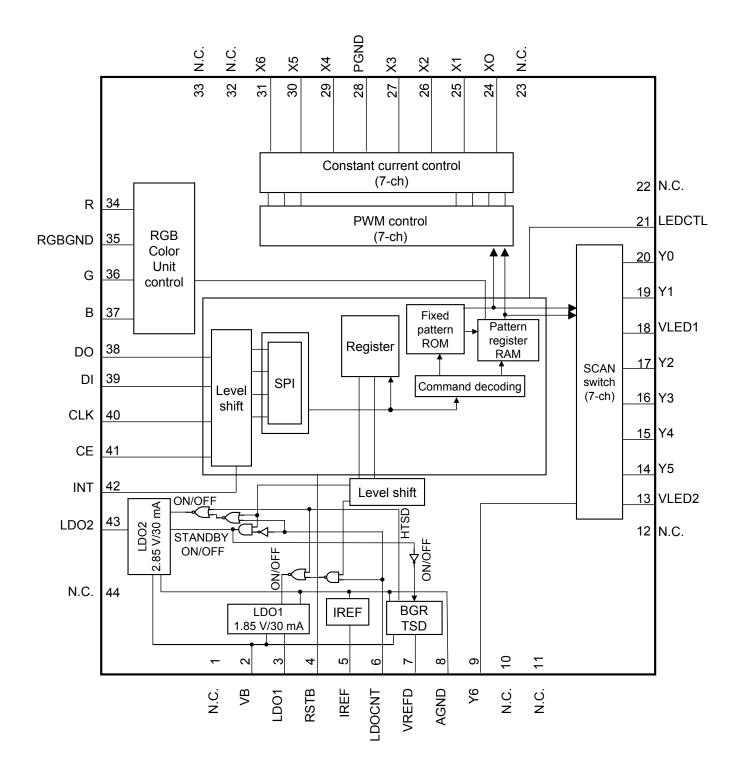


## **PIN FUNCTIONS (continued)**

Pin No.	Pin name	Туре	Description
24	X0	Output	Constant current circuit. The output terminal of PWM control. It connects with the 1st Row of matrix LED.
25	X1	Output	Constant current circuit. The output terminal of PWM control. It connects with the 2nd Row of matrix LED.
26	X2	Output	Constant current circuit. The output terminal of PWM control. It connects with the 3rd Row of matrix LED.
27	X3	Output	Constant current circuit. The output terminal of PWM control. It connects with the 4th Row of matrix LED.
28	PGND	Ground	The GND terminal for matrix LED
29	X4	Output	Constant current circuit. The output terminal of PWM control. It connects with the 5th Row of matrix LED.
30	X5	Output	Constant current circuit. The output terminal of PWM control. It connects with the 6th Row of matrix LED.
31	X6	Output	Constant current circuit. The output terminal of PWM control. It connects with the 7th Row of matrix LED.
34	R	Output	LED contact terminal.
35	RGBGND	Ground	The GND terminal for RGB terminal.
36	G	Output	LED contact terminal.
37	В	Output	LED contact terminal.
38	DO	Output	Data output terminal for SPI interface.
39	DI	Input	Data input terminal for SPI interface.
40	CLK	Input	Clock input terminal for SPI interface.
41	CE	Input	Chip-enable terminal for SPI1 interface. ("H" active )
42	INT	Output	Interrupt output terminal.
43	LDO2	Output	LDO2(2.85 V)output terminal.



## FUNCTIONAL BLOCK DIAGRAM



Notes: This block diagram is for explaining functions. Part of the block diagram may be omitted, or it may be simplified.

Established : 2007-05-24 Revised : 2013-04-15

## **OPERATION**

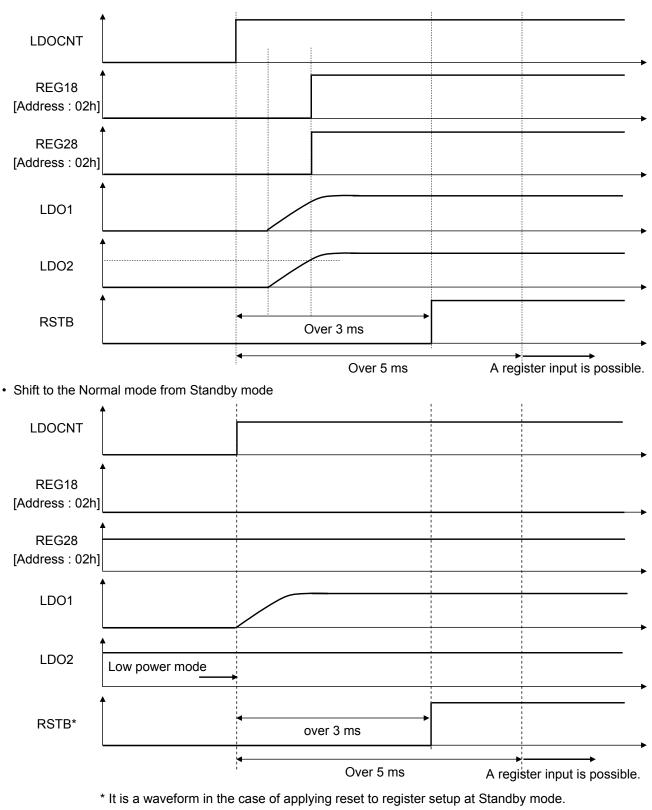
#### 1. Explanation in each mode (Power supply starting sequence)

Mode	LDOCNT	REG18	REG28	Note
OFF	Low	0	0	<ul> <li>It is necessary to make it LDOCNT = High for the return from OFF-mode.</li> </ul>
OFF → Normal mode	"L" → "H"	0/1	0/1	<ul> <li>The signal from serial interface is not received in LDOCNT = Low and the state of REG28 = Low or REG18 = Low.</li> <li>It shifts to standby mode with LDOCNT = Low and REG28 = High.</li> <li>The signal from serial interface is not received at Standby-mode. (Power supply for Logic is LDO1 and LDO2.) Therefore, standby release by the signal from serial interface cannot be performed.</li> </ul>
	"H"	0/1	0/1	<ul> <li>In Standby-mode, if LDOCNT is switched to High from Low, it will return to the normal mode.</li> <li>It cannot shift to OFF-mode from Standby-mode. Once returning to the normal mode, please shift to OFF-mode.</li> </ul>
Normal mode → OFF		0	0	<ul> <li>Regardless of the value of REG18, LDO1 turns on at LDOCNT = High.</li> <li>Regardless of the value of REG28, LDO2 turns on at LDOCNT = High.</li> <li>Serial interface signal is not received at RSTB = Low</li> </ul>
Normal mode → Standby mode	"H" → "L"	0	1	<ul> <li>5 ms after being set to LDOCNT = High, the receptionist of serial interface signal is attained.</li> <li>RSTB terminal prohibits the input signal of those other than a rectangle wave.</li> <li>All register setting become default setting if RSTB = Low</li> <li>(The default setting of REG18 and REG28 are [1]</li> <li>If RSTB = Low before LDOCNT = Low, LDO1 and LDO2 can't turn off. )</li> <li>All register setting become default setting when LDO2 turn off.</li> <li>The setting order to change off mode is as following.</li> <li>REG18, 28 = [0] → LDOCNT = "L" → RSTB = "L"</li> </ul>



#### 1. Explanation in each mode (Power supply starting sequence) (continued)

• Shift to the Normal mode from OFF-mode

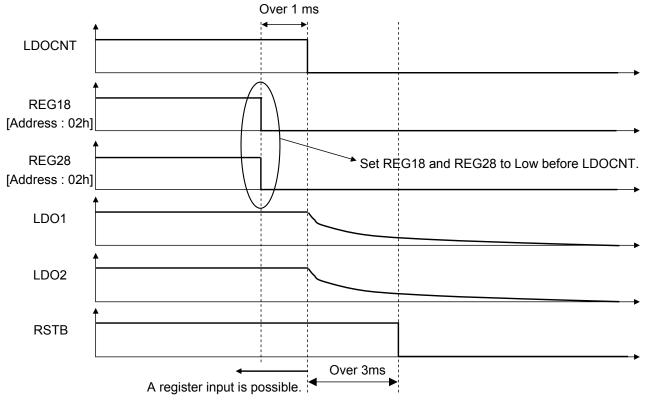


\* Maintain the state of RSTB = High to hold the register setup.

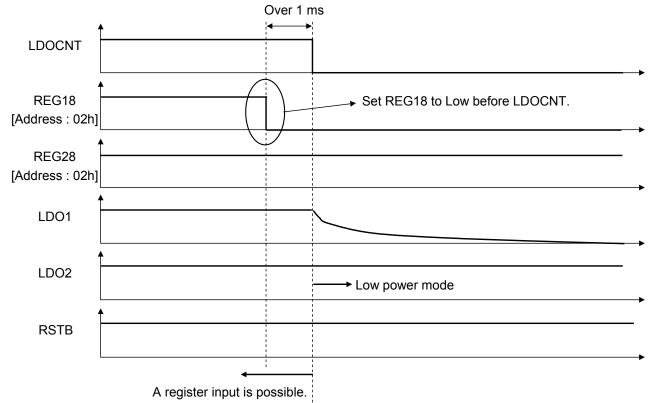


#### 1. Explanation in each mode (Power supply starting sequence) (continued)

· Shift to the OFF-mode from Normal mode



· Shift to the Standby mode from Normal mode





#### 1. Explanation in each mode (Power supply starting sequence) (continued)

· Shift to the OFF-mode from Normal mode

VBAT	LDOCNT	MODE
"L"	"L"	OFF
"L"	"H"	Prohibition
"H"	"L"	OFF
"H"	"H"	ON

Note) "L" in column of VBAT and LDOCNT means 0 V, "H" means 3.1 to 4.6 V (operating supply voltage range).

#### Logic pin condition

The following setting is common for OFF, Standby and Normal mode. The pin setting when RSTB = Low, under Normal mode is as follows.

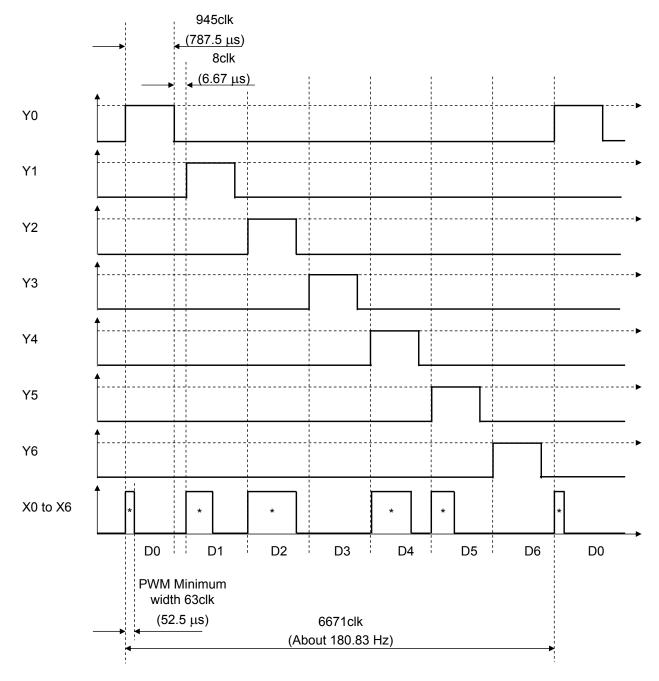
Pin name	Pin state	Logic*
INT	Output	"L"
CE	Input	"L"
CLK	Input	"L"
DI	Input	"L"
DO	Output	"L"
LEDCTL	Input	"L"
LDOCNT	Input	Depends on each mode

Note)\*: Logic state for pins indicated as "Output" under Pin state shows the output level. Logic state for pins indicated as "Input" under Pin state shows the input level to be set to the pins.



#### 2. Explanation of operation

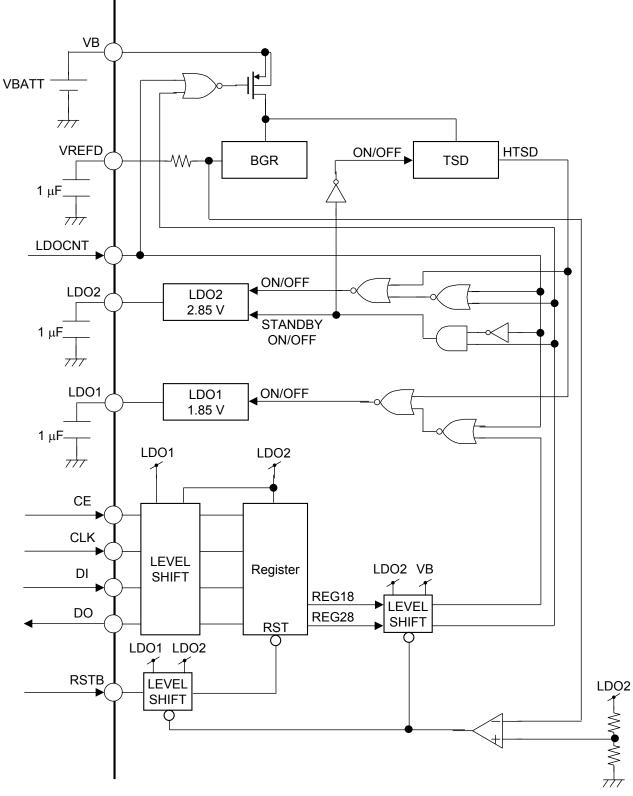
- · Matrix part operation waveform
- The following waveform is an internal signal. In following Yx = Xx = Low, the waveform of actual Yx terminal is set to Hi-Z.
- It is controlled by internal 1.2 MHz clock in default condition.
- Y side switches from Y0 to Y6 in that order. The turning on term of each pin is constant 945clock (787.5 μs) and each turning on term includes 8clock (6.67 μs) interval.
- "\*" mark shows the turning on term and D3, D6 is the turning off term in the following figure.
- 7×7 matrix display is controlled by X0 to X6 with Yx switching timing.





#### 3. Block configuration

RESET part block configuration

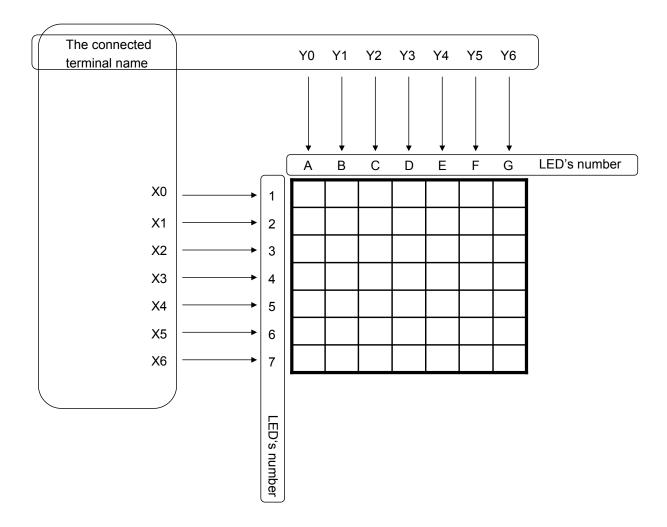


All the logic portions to which the power supply is not connected are connected to VB as power supplies.



#### 3. Block configuration (continued)

- Explanation of matrix LED part, matrix LED's number
- LED matrix driver circuit can display character and pattern by controlling the 7×7 matrix LED individually.
- In this specification, LED's number controlled by each terminal can be matched off against the following figure.
- It is controlled by internal 1.2 MHz clock in default condition.
- In the scroll mode, LED matrix can move the display of character from right to left as the following arrangement.

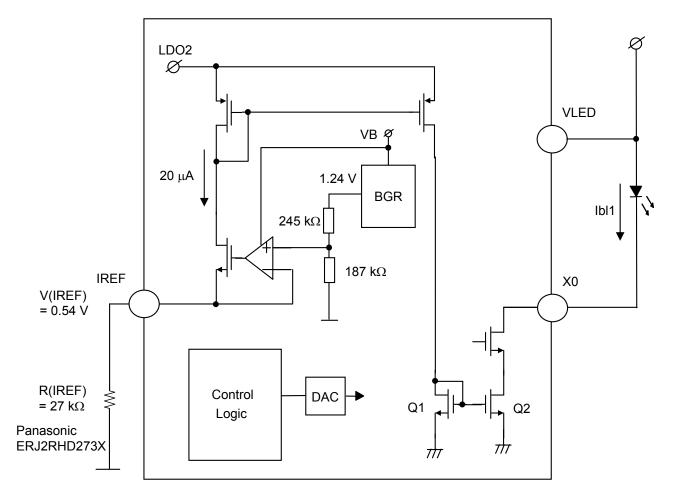




#### 3. Block configuration (continued)

• Equivalent circuit of matrix LED driver

#### X0 terminal case



- The reference current for constant current driver is calculated by the following formula. V(IREF) / R(IREF) = 0.54 V / 27 k $\Omega$  = 20  $\mu$ A
- The LED driver current can be set from 0 mA to 30 mA by register setting via serial interface.
- The constant current value can be changed by the external resistor value of IREF terminal, but the accuracy in case of that setting is not guaranteed.
- ERJ2RHD273X is recommended for the external resistor of IREF terminal to keep the constant current accuracy.



- 4. Register and Address
  - Register Map

Sub	R/W	Dete nome		Data							
address	R/W	Data name	D7	D6	D5	D4	D3	D2	D1	D0	
01h	W	POWERCNT		_	_	_	_	OSCEN	_	—	
02h	W	LDOCNT					_		REG18	REG28	
03h					For	test					
04h					For	test					
05h					For	test					
06h					For	test					
07h					For	test					
08h					For	test					
09h			· · · · · · · · · · · · · · · · · · ·		For	test					
0Ah	W	LEDCTL	LEDACT	—	_	_	_	DISMTX	DISRGB		
10h					For	test					
11h					For	test					
12h					For	test					
13h					For	test					
14h	R	IOFACTOR	FACGD1	_	_	_	RAM ACT	FRMINT	CPUWRER	TSD	
15h					For	test					
16h					For	test					
17h					For	test					
18h					For	test					
19h					For	test					
1Ah	W/R	VDDSEL	INTVSEL	_			_	_			



## 4. Register and Address (continued)

• Register Map (continued)

Sub	Dav	Data Nama	DATA							
Address	R/W	Data Name	D7	D6	D5	D4	D3	D2	D1	D0
20h	R/W	MTXON								MTXON
21h	R/W	MTXDATA					MTXDAT	A[7:0]		
22h	R/W	FFROM							ROI	W77[1:0]
23h	R/W	ROMSEL					SELRON	1[7:0]		
24h	R/W	RAMCOPY							SELRAM	COPYSTART
25h	R/W	SETFROM				Ś	SETFROM	v[7:0]		
26h	R/W	SETTO					SETTO	[7:0]		
27h	R/W	REPON								REPON
28h	R/W	SETTIME							SET	TIME[1:0]
29h	R/W	RAMRST			_				RAM1	RAM2
2Ah	R/W	SCROLL								SCLON
2Bh					Fc	or test				
2Ch	R/W	RGBON								RGBON
2Dh	R/W	RGBDATA					ĺ	RGBDAT	A[5:0]	
2Eh					Fc	or test				
30h	R/W	RAMNUM								RAMNUM
			•							
6Bh					Fc	or test				
6Dh					Fc	or test				
6Fh					Fc	or test				
70h					Fc	or test				
71h					Fc	or test				
72h					Fc	or test				
73h					Fc	or test				
74h					Fc	or test				
75h					Fc	or test				
76h					Fc	or test				
77h					Fc	or test				

\* Access the address from 6Bh to 77h is prohibited.



## AN32058A

## **OPERATION** (continued)

## 4. Register and Address (continued)

RAM address map

Sub	D. ( N.				DA	ATA				
Address	Data Name	D7	D6	D5	D4	D3	D2	D1	D0	
31h	A1	BLA1[3:0]				FRA	FRA1[1:0]		DLA1[1:0]	
32h	A2	BLA2[3:0]			FRA	FRA2[1:0]		2[1:0]		
33h	A3		BLA	3[3:0]		FRA	3[1:0]	DLA	3[1:0]	
34h	A4		BLA	4[3:0]		FRA	4[1:0]	DLA	4[1:0]	
35h	A5		BLA	5[3:0]		FRA	5[1:0]	DLA	5[1:0]	
36h	A6		BLA	6[3:0]		FRA	6[1:0]	DLA	6[1:0]	
37h	A7		BLA	7[3:0]		FRA	7[1:0]	DLA	7[1:0]	
38h	B1		BLB	1[3:0]		FRB	1[1:0]	DLB	1[1:0]	
39h	B2		BLB	2[3:0]		FRB	2[1:0]	DLB	2[1:0]	
3Ah	B3		BLB:	3[3:0]		FRB	3[1:0]	DLB	3[1:0]	
3Bh	B4		BLB	4[3:0]		FRB	4[1:0]	DLB4[1:0]		
3Ch	B5		BLB	5[3:0]		FRB	5[1:0]	DLB5[1:0]		
3Dh	B6		BLB	6[3:0]		FRB	6[1:0]	DLB6[1:0]		
3Eh	B7		BLB.	7[3:0]		FRB	7[1:0]	DLB	DLB7[1:0]	
3Fh	C1		BLC	1[3:0]		FRC	1[1:0]	DLC1[1:0]		
40h	C2		BLC	2[3:0]		FRC	2[1:0]	DLC	2[1:0]	
41h	C3		BLC	3[3:0]		FRC	3[1:0]	DLC	3[1:0]	
42h	C4		BLC	4[3:0]		FRC	4[1:0]	DLC	4[1:0]	
43h	C5		BLC	5[3:0]		FRC	5[1:0]	DLC	5[1:0]	
44h	C6		BLC	6[3:0]		FRC	6[1:0]	DLC	6[1:0]	
45h	C7		BLC	7[3:0]		FRC	7[1:0]	DLC	7[1:0]	
46h	D1		BLD	1[3:0]		FRD	1[1:0]	DLD	1[1:0]	
47h	D2		BLD	2[3:0]		FRD	2[1:0]	DLD	2[1:0]	
48h	D3		BLD:	3[3:0]		FRD	3[1:0]	DLD	3[1:0]	
49h	D4		BLD	4[3:0] FRD4[1:0]			4[1:0]	DLD	4[1:0]	
4Ah	D5		BLD	5[3:0]		FRD	5[1:0]	DLD	5[1:0]	
4Bh	D6		BLD	6[3:0]		FRD	6[1:0]	DLD	6[1:0]	
4Ch	D7		BLD	7[3:0]		FRD	7[1:0]	DLD	7[1:0]	



## AN32058A

## **OPERATION** (continued)

## 4. Register and Address (continued)

RAM address map (continued)

Sub	Dete Neme	DATA								
Address	Data Name	D7	D6	D5	D4	D3	D2	D1	D0	
4Dh	E1		BLE	1[3:0]		FRE1[1:0]		DLE	DLE1[1:0]	
4Eh	E2		BLE2	2[3:0]		FRE	2[1:0]	DLE	2[1:0]	
4Fh	E3		BLE	3[3:0]		FRE	3[1:0]	DLE	3[1:0]	
50h	E4		BLE4	4[3:0]		FRE	4[1:0]	DLE	4[1:0]	
51h	E5		BLE	5[3:0]		FRE	5[1:0]	DLE	5[1:0]	
52h	E6		BLE	6[3:0]		FRE	6[1:0]	DLE	6[1:0]	
53h	E7		BLE	7[3:0]		FRE	7[1:0]	DLE	7[1:0]	
54h	F1		BLF	1[3:0]		FRF	1[1:0]	DLF	1[1:0]	
55h	F2		BLF2	2[3:0]		FRF2	2[1:0]	DLF2[1:0]		
56h	F3		BLF	3[3:0]		FRF3[1:0]		DLF3[1:0]		
57h	F4		BLF4	4[3:0]		FRF4[1:0]		DLF4[1:0]		
58h	F5		BLF	5[3:0]		FRF	FRF5[1:0]		DLF5[1:0]	
59h	F6		BLF6	6[3:0]		FRF6[1:0]		DLF6[1:0]		
5Ah	F7		BLF7	7[3:0]		FRF7[1:0]		DLF	7[1:0]	
5Bh	G1		BLG	1[3:0]		FRG	1[1:0]	DLG	1[1:0]	
5Ch	G2		BLG	2[3:0]		FRG	2[1:0]	DLG	2[1:0]	
5Dh	G3		BLG:	3[3:0]		FRG	3[1:0]	DLG	3[1:0]	
5Eh	G4		BLG	4[3:0]		FRG	4[1:0]	DLG	4[1:0]	
5Fh	G5		BLG	5[3:0]		FRG	5[1:0]	DLG	5[1:0]	
60h	G6		BLG	6[3:0]		FRG	6[1:0]	DLG	6[1:0]	
61h	G7		BLG	BLG7[3:0] FRG7[1:0]		7[1:0]	DLG	7[1:0]		
62h	LEDR	BLLEDR[3:0]			BLLEDR[3:0] FRLEDR[1:0]		DR[1:0]	DLLE	DR[1:0]	
63h	LEDG		BLLED	)G[3:0]		FRLEE	DG[1:0]	DLLED	DG[1:0]	
64h	LEDB		BLLED	DB[3:0]		FRLE	DB[1:0]	DLLE	DB[1:0]	



#### 4. Register and Address (continued)

ROM Address Map

[00000000] - [10010101] : ROM(Only luminosity) 7 × 7 Pattern No.0 (default) to Pattern No.149

Pattern No.	Contents of the pattern	Display	Pattern No.	Contents of the pattern	Display
0	All putting out lights	Nothing	31	Alphabetic character	U
1	Number	0	32	Alphabetic character	V
2	Number	1	33	Alphabetic character	W
3	Number	2	34	Alphabetic character	Х
4	Number	3	35	Alphabetic character	Y
5	Number	4	36	Alphabetic character	Z
6	Number	5	37	Alphabetic character	а
7	Number	6	38	Alphabetic character	b
8	Number	7	39	Alphabetic character	с
9	Number	8	40	Alphabetic character	d
10	Number	9	41	Alphabetic character	е
11	Alphabetic character	A	42	Alphabetic character	f
12	Alphabetic character	В	43	Alphabetic character	g
13	Alphabetic character	С	44	Alphabetic character	h
14	Alphabetic character	D	45	Alphabetic character	i
15	Alphabetic character	E	46	Alphabetic character	j
16	Alphabetic character	F	47	Alphabetic character	k
17	Alphabetic character	G	48	Alphabetic character	I
18	Alphabetic character	Н	49	Alphabetic character	m
19	Alphabetic character	I	50	Alphabetic character	n
20	Alphabetic character	J	51	Alphabetic character	0
21	Alphabetic character	К	52	Alphabetic character	р
22	Alphabetic character	L	53	Alphabetic character	q
23	Alphabetic character	М	54	Alphabetic character	r
24	Alphabetic character	N	55	Alphabetic character	S
25	Alphabetic character	0	56	Alphabetic character	t
26	Alphabetic character	Р	57	Alphabetic character	u
27	Alphabetic character	Q	58	Alphabetic character	v
28	Alphabetic character	R	59	Alphabetic character	w
29	Alphabetic character	S	60	Alphabetic character	x
30	Alphabetic character	Т	61	Alphabetic character	у



#### 4. Register and Address (continued)

ROM Address Map (continued)

[00000000] - [10010101] : ROM(Only luminosity) 7×7 Pattern No.0 (default) to Pattern No.149

Pattern No.	Contents of the pattern	Display	Pattern No.	Contents of the pattern	Display
62	Alphabetic character	Z	93	Number	30
63	Number	00	94	Number	31
64	Number	01	95	Number	32
65	Number	02	96	Number	33
66	Number	03	97	Number	34
67	Number	04	98	Number	35
68	Number	05	99	Number	36
69	Number	06	100	Number	37
70	Number	07	101	Number	38
71	Number	08	102	Number	39
72	Number	09	103	Number	40
73	Number	10	104	Number	41
74	Number	11	105	Number	42
75	Number	12	106	Number	43
76	Number	13	107	Number	44
77	Number	14	108	Number	45
78	Number	15	109	Number	46
79	Number	16	110	Number	47
80	Number	17	111	Number	48
81	Number	18	112	Number	49
82	Number	19	113	Number	50
83	Number	20	114	Number	51
84	Number	21	115	Number	52
85	Number	22	116	Number	53
86	Number	23	117	Number	54
87	Number	24	118	Number	55
88	Number	25	119	Number	56
89	Number	26	120	Number	57
90	Number	27	121	Number	58
91	Number	28	122	Number	59
92	Number	29	123	Number	60



#### 4. Register and Address (continued)

• ROM Address Map (continued)

[00000000] - [10010101] : ROM(Only luminosity) 7×7 Pattern No.0 (default) to Pattern No.149

Pattern No.	Contents of the pattern	Display	Pattern No.	Contents of the pattern	Display
124	Symbol	Zero antenna	144	Symbol	
125	Symbol	One antenna			
126	Symbol	Two antenna	145	Symbol	
127	Symbol	Three antenna	140	Quercheal	
128	Symbol		146	Symbol	
129	Symbol				
130	Symbol	I	147	Symbol	
131	Symbol	>>			
132	Symbol	<<			
133	Symbol	:	148	Symbol	
134	Symbol	!			
135	Symbol	?	149	Symbol	
136	Symbol				
137	Symbol	▼			
138	Symbol	$\leftarrow$			
139	Symbol	$\rightarrow$			
140	Symbol	+			
141	Symbol	-			
142	Symbol	/			
143	Symbol				



#### 4. Register and Address (continued)

ROM Address Map (continued)

Pattern No.	Contents of the pattern	Display	Pattern No.	Contents of the pattern	Display
150	Gradation		159	Gradation	
151	Gradation		160	Gradation	
152	Gradation		161	Gradation	
153	Gradation		162	Gradation	
154	Gradation		163	Gradation	
155	Gradation		164	Gradation	
156	Gradation		165	Gradation	
157	Gradation		166	Gradation	
158	Gradation		167	Gradation	



#### 4. Register and Address (continued)

• ROM Address Map (continued)

Pattern No.	Contents of the pattern	Display	Pattern No.	Pattern No. Contents of the pattern	
168	Gradation		177	Gradation	
169	Gradation		178	Gradation	
170	Gradation		179	Gradation	
171	Gradation		180	Gradation	
172	Gradation		181	Gradation	
173	Gradation		182	Gradation	
174	Gradation		183	Gradation	
175	Gradation		184	Gradation	
176	Gradation		185	Gradation	



#### 4. Register and Address (continued)

• ROM Address Map (continued)

Pattern No.	Contents of the pattern	Display	Pattern No.	Contents of the pattern	Display
186	Gradation		195	Gradation	
187	Gradation		196	196 Gradation	
188	Gradation		197	197 Gradation	
189	Gradation		198	Gradation	
190	Gradation		199	Gradation	
191	Gradation		200	Gradation	
192	Gradation		201	201 Gradation	
193	Gradation		202	Gradation	
194	Gradation		203	Gradation	



#### 4. Register and Address (continued)

• ROM Address Map (continued)

Pattern No.	Contents of the pattern	Display
204	Gradation	
205	Gradation	
206	Gradation	
207	Gradation	
208	Gradation	



#### 4. Register and Address (continued)

• Register table which needs a clock

About the following addresses, even if an internal clock or an external clock does not exist, Read / Write is possible in the data to register. However, it cannot be given to operation finally needed.

Sub	Dav	Data Nama	DATA							
Address R/W	Data Name	D7	D6	D5	D4	D3	D2	D1	D0	
01h	W	POWERCNT	_	_	_	_	_	OSCEN	_	_
14h	R	IOFACTOR	FACG D1	—	_	_	RAM ACT	FRMINT	CPU WRER	TSD
20h	R/W	MTXON	_	_	_	_	_	_	_	MTXON
21h	R/W	MTXDATA	MTXDATA[7:0]							
22h	R/W	FFROM	—	_	_	_	—	—	ROM77[1:0]	
23h	R/W	ROMSEL	SELROM[7:0]							
24h	R/W	RAMCOPY	_	_	_	_	_	_	SELRAM	COPY START
25h	R/W	SETFROM	SETFROM[7:0]							
26h	R/W	SETTO					SETT	O[7:0]		
27h	R/W	REPON	_	_	_	_	_	_	_	REPON
28h	R/W	SETTIME	—	_	_	_	—	—	SETTIME[1:0]	
29h	R/W	RAMRST	—	_	_	_	_	—	RAM1	RAM2
2Ah	R/W	SCROLL	—				_	_	_	SCLON
2Bh	R/W	SCLTIME	—				_	_	SCLTIME[1:0]	
2Ch	R/W	RGBON	_	_	_	_	_	_	_	RGBON
2Dh	R/W	RGBDATA	— — RGBDATA[5:0]							
30h	R/W	RAMNUM	_				_	_	_	RAMNUM



#### 4. Register and Address (continued)

• Register table which needs a clock (continued)

About the following addresses, when an internal clock or an external clock does not exist, data cannot be Read / Write in at register.

	Dete News				DA	TA			
Sub Address	Data Name	D7	D6	D5	D4	D3	D2	D1	D0
31h	A1		BLA	1[3:0]		FRA	1[1:0]	DLA	1[1:0]
32h	A2		BLA	2[3:0]		FRA	2[1:0]	DLA	2[1:0]
33h	A3		BLA	3[3:0]		FRA:	3[1:0]	DLA:	3[1:0]
34h	A4		BLA	4[3:0]		FRA	4[1:0]	DLA	4[1:0]
35h	A5	BLA5[3:0]				FRA	5[1:0]	DLA	5[1:0]
36h	A6	BLA6[3:0]				FRA	6[1:0]	DLA	6[1:0]
37h	A7	BLA7[3:0]				FRA	7[1:0]	DLA	7[1:0]
38h	B1		BLB	1[3:0]		FRB	1[1:0]	DLB	1[1:0]
39h	B2	BLB2[3:0]				FRB:	2[1:0]	DLB	2[1:0]
3Ah	B3	BLB3[3:0]				FRB:	3[1:0]	DLB:	3[1:0]
3Bh	B4	BLB4[3:0]				FRB	4[1:0]	DLB4	4[1:0]
3Ch	B5		BLB5[3:0] FRB5[1:0]				5[1:0]	DLB	5[1:0]
3Dh	B6		BLB	6[3:0]		FRB	6[1:0]	DLB6[1:0]	
3Eh	B7		BLB	7[3:0]		FRB	7[1:0]	DLB	7[1:0]
3Fh	C1		BLC	1[3:0]		FRC	1[1:0]	DLC	1[1:0]
40h	C2		BLC2[3:0] FRC2[1:0]			DLC	2[1:0]		
41h	C3		BLC	3[3:0]		FRC	3[1:0]	DLC:	3[1:0]
42h	C4		BLC	4[3:0]		FRC	4[1:0]	DLC	4[1:0]
43h	C5		BLC	5[3:0]		FRC	5[1:0]	DLC:	5[1:0]
44h	C6		BLC	6[3:0]		FRC	6[1:0]	DLC	6[1:0]
45h	C7		BLC	7[3:0]		FRC	7[1:0]	DLC.	7[1:0]
46h	D1		BLD	1[3:0]		FRD	1[1:0]	DLD	1[1:0]
47h	D2		BLD	2[3:0]		FRD	2[1:0]	DLD:	2[1:0]
48h	D3		BLD	3[3:0]		FRD	3[1:0]	DLD:	3[1:0]
49h	D4	BLD4[3:0]			BLD4[3:0] FRD4[1:0]			DLD	4[1:0]
4Ah	D5	BLD5[3:0]			BLD5[3:0] FRD5[1:0]			DLD	5[1:0]
4Bh	D6	BLD6[3:0]				FRD6[1:0]		DLD	6[1:0]
4Ch	D7		BLD7[3:0] FRD7[1:0]			7[1:0]	DLD.	7[1:0]	



#### 4. Register and Address (continued)

• Register table which needs a clock (continued)

About the following addresses, when an internal clock or an external clock does not exist, data cannot be Read / Write in at register.

Cub Address	Dete News				DA	TA			
Sub Address	Data Name	D7	D6	D5	D4	D3	D2	D1	D0
4Dh	E1		BLE	1[3:0]	·	FRE	1[1:0]	DLE	1[1:0]
4Eh	E2		BLE	2[3:0]		FRE	2[1:0]	DLE	2[1:0]
4Fh	E3		BLE:	3[3:0]		FRE	3[1:0]	DLE	3[1:0]
50h	E4		BLE	4[3:0]		FRE	4[1:0]	DLE	4[1:0]
51h	E5		BLE	5[3:0]		FRE	5[1:0]	DLE	5[1:0]
52h	E6		BLE	6[3:0]		FRE	6[1:0]	DLE	6[1:0]
53h	E7		BLE	7[3:0]		FRE	7[1:0]	DLE	7[1:0]
54h	F1	BLF1[3:0]				FRF	1[1:0]	DLF	1[1:0]
55h	F2	BLF2[3:0]				FRF	2[1:0]	DLF2[1:0]	
56h	F3	BLF3[3:0]				FRF	3[1:0]	DLF3[1:0]	
57h	F4		BLF4	4[3:0]		FRF	4[1:0]	DLF4[1:0]	
58h	F5		BLF	5[3:0]		FRF	5[1:0]	DLF	5[1:0]
59h	F6		BLF	6[3:0]		FRF	6[1:0]	DLF	6[1:0]
5Ah	F7		BLF	7[3:0]		FRF	7[1:0]	DLF7[1:0]	
5Bh	G1		BLG	1[3:0]		FRG	1[1:0]	DLG	1[1:0]
5Ch	G2		BLG	2[3:0]		FRG	2[1:0]	DLG	2[1:0]
5Dh	G3		BLG	3[3:0]		FRG	3[1:0]	DLG	3[1:0]
5Eh	G4		BLG	4[3:0]		FRG	4[1:0]	DLG	4[1:0]
5Fh	G5		BLG	5[3:0]		FRG	5[1:0]	DLG	5[1:0]
60h	G6		BLG	6[3:0]		FRG	6[1:0]	DLG	6[1:0]
61h	G7	BLG7[3:0]				FRG	7[1:0]	DLG	7[1:0]
62h	LEDR	BLLEDR[3:0]			BLLEDR[3:0] FRLEDR[1:0]		DR[1:0]	DLLE	DR[1:0]
63h	LEDG	BLLEDG[3:0]			BLLEDG[3:0] FRLEDG[1:0]			DLLE	DG[1:0]
64h	LEDB		BLLEDB[3:0] FRLEDB[1:0]				DB[1:0]	DLLE	DB[1:0]



#### 4. Register and Address (continued)

Register map detailed explanation

S.	h Addroop		DATA										
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0				
	Data Name	_	_	_	_	—	OSCEN	_	—				
01h	Default	0	0	0	0	0	0	0	0				
	mode	W	W	W	W	W	W	W	W				

D2 : OSCEN ON/OFF bit for internal oscillators

[0] : Internal oscillating circuit is OFF (default)

- [1] : Internal oscillating circuit is ON
- The variation width of an internal oscillator is set to 0.96MHz 1.44 MHz.
- The variation width of an internal clock is set to 694.4 ns 1042 ns.

<b>S</b>	h Address				DA	ATA			
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0
	Data Name	_	_	_	_	_	_	REG18	REG28
02h	Default	0	0	0	0	0	0	1	1
	mode	W	W	W	W	W	W	W	W

D1 : REG18 The ON/OFF control for LDO1(When LDOCNT terminal is Low)

[0] : LDO1 OFF

[1] : LDO1 ON (default)

D0 : REG28 The ON/OFF control for LDO2( When LDOCNT terminal is Low )

[0] : LDO2 OFF

[1] : LDO2 ON (default)

• When LDOCNT terminal is High, regardless of the state of REG18, LDO1 will be activated.

• When LDOCNT terminal is High, regardless of the state of REG28, LDO2 will be activated.

• Set LDOCNT to Low after setting REG28 to Low to put into OFF mode.



## 4. Register and Address (continued)

Register map detailed explanation (continued)

C.u	h Adducco				DA	ТА					
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0		
	Data Name		-	-	For	test					
03h	Default	0	0	0	0	0	0	0	0		
	mode	W	W	W	W	W	W	W	W		
					DA	TA					
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0		
	Data Name				For	test					
04h	Default	0	0	0	0	0	0	0	0		
	mode	R	R	R	R	R	R	R	R		
			DATA								
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0		
	Data Name				For	test					
05h	Default	0	0	0	0	0	0	0	0		
	mode	W	W	w	W	W	W	W	W		
<b>C</b>	b Address				DA	ТА					
Su	D Address	D7	D6	D5	D4	D3	D2	D1	D0		
	Data Name		1		For	test	1				
06h	Default	0	0	0	0	0	0	0	0		
	mode	W	W	W	W	W	W	W	W		
	b Address		DATA								
Su	D Address	D7	D6	D5	D4	D3	D2	D1	D0		
	Data Name				For	test					
07h	Default	0	0	0	0	0	0	0	0		
	mode	W	W	w	W	W	W	w	W		

\*Don't access to address from 03h to 07h.



#### 4. Register and Address (continued)

Register map detailed explanation (continued)

<b></b>					DA	TA					
Su	b Address	D7	D7 D6 D5 D4 D3 D2 D1								
	Data Name		For test								
08h	Default	0	0	0	0	0	0	0	0		
	mode	W	W	W	W	W	W	W	W		

<b>S</b>	b Address		DATA										
Su	D7 D6 D5 D4 D3 D2							D1	D0				
	Data Name		For test										
09h	Default	0	0	0	0	0	0	0	0				
	mode	W	W	W	W	W	W	W	W				

\*Don't access to address from 08h to 09h.

<b>C</b>			DATA										
Su	ıb Address	D7	D6	D5	D4	D3	D2	D1	D0				
	Data Name	LEDACT	—	—	—	—	DISMTX	DISRGB	—				
0Ah	Default	0	0	0	0	0	0	0	0				
	mode	W	W	W	W	W	W	W	W				

D7 : LEDACT A putting-out-lights setup of LED by LEDCTL terminal.

[0] : The light is switched on at LEDCTL = Low(default)

[1] : The light is switched on at LEDCTL = High

D2 : DISMTX A putting-out-lights ON/OFF setup of  $7 \times 7$  dots matrix LED by LEDCTL terminal.

[0] : Putting-out-lights control OFF by LEDCTL terminal. (default)

[1] : Putting-out-lights control ON by LEDCTL terminal.

D1 : DISRGB A putting-out-lights ON/OFF setup of R, G and B terminal by LEDCTL terminal.

[0] : Putting-out-lights control OFF by LEDCTL terminal. (default)

[1] : Putting-out-lights control ON by LEDCTL terminal.



#### 4. Register and Address (continued)

Register map detailed explanation (continued)

0	h. A dalaa a a				DA	ТА			
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0
	Data Name				For	test			
10h	Default	0	0	0	0	0	0	0	0
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R
					DA	TA			
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0
	Data Name				For	test			
11h	Default	0	0	0	0	0	0	0	0
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R
					DA	TA			
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0
	Data Name				For	test			
12h	Default	0	0	0	0	0	0	0	0
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R
					DA	TA			
Su	b Address	D7 D6 D5 D4 D3 D2 D1 I							
	Data Name				For	test		· · · · · · · · · · · · · · · · · · ·	
13h	Default	0	0	0	0	0	0	0	0
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R

\*Don't access to address from 10h to 13h.



#### 4. Register and Address (continued)

Register map detailed explanation (continued)

<b></b>	b Address					DATA			
Su	id Address	D7	D6	D5	D4	D3	D2	D1	D0
	Data Name	FACGD1	_	_	_	RAMACT	FRMINT	CPUWRER	TSD
14h	Default	0	0	0	0	0	0	0	0
	mode	R	R	R	R	R	R	R	R

#### D7 : FACGD1

[0] : Normal operation (default)

[1] : No read clearance

#### D3 : RAMACT Internal RAM access judgment

- [0] : RAM is not accessed. (default)
- [1] : RAM is accessed.

#### D2 : FRMINT Frame display end judgment during scroll display

- [0] : Under frame display (default)
- [1] : Frame display end

#### D1 : CPUWRER CPU access error judgment

- [0] : CPU access error does not occur. (default)
- [1] : CPU access error occurs.

D0 : TSD Abnormal detection of TSD error

- [0] : TSD abnormal detection does not occur. (default)
- [1] : TSD abnormal detection occurs.

#### • CPUWRER indicates the error when CPU writes the data to 31h to 64h during copying from ROM to RAM1 or RAM2.

- The WRITE contents from CPU are not reflected in this LSI at CPUWRER = High. Write from CPU again.
- The interval of FACGD1 = "1" is maximum 1.93 µs (at the internal clock operation) from the renewal time of data.
- At FACGD1 = "1", if address 14h data is read, data of D0 to D6 are cleared.
- RAM access from CPU cannot be performed at RAMACT = "1" .
- When each address 14h register is set to High, the pulse in a cycle of 4 ms is output from INT.
- The pulse output from INT continues an output until address 14h is read.
- RSTB terminal = Low can reset to stop the INT pulse signal in case of that the serial read function is not used.
- The states for RAMACT = "1" are shown below.
  - 1. While copying to RAM from ROM.
    - 2. While clearing RAM



### 4. Register and Address (continued)

Register map detailed explanation (continued)

					DA	TA						
SI	ub Address	D7	D6	D5	D4	D3	D2	D1	D0			
	Data Name				For	test						
15h	Default	0	0	0	0	0	0	0	0			
	mode	R	R	R	R	R	R	R	R			
					DA	TA						
ິຣເ	ub Address	D7	D6	D5	D4	D3	D2	D1	D0			
	Data Name				For	test						
16h	Default	0	0	0	0	0	0	0	0			
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R			
			DATA									
SL	ub Address	D7	D6	D5	D4	D3	D2	D1	D0			
	Data Name	For test										
17h	Default	0	0	0	0	0	0	0	0			
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R			
		DATA										
ິຣເ	ub Address	D7	D6	D5	D4	D3	D2	D1	D0			
	Data Name				For	test						
18h	Default	0	0	0	0	0	0	0	0			
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R			
					DA	TA						
SI	ub Address	D7	D6	D5	D4	D3	D2	D1	D0			
	Data Name				For	test	·					
19h	Default	0	0	0	0	0	0	0	0			
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R			

\*Don't access to address from 15h to 19h.



### 4. Register and Address (continued)

Register map detailed explanation (continued)

<b>C</b>	h Address		DATA											
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0					
	Data Name	INTVSEL	_	_		_	_	_	—					
1Ah	Default	0	0	0	0	0	0	0	0					
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R					

D7 : INTVSEL The voltage setup of INT terminal

[0] : 1.85 V (default)

[1] : 2.85 V



#### 4. Register and Address (continued)

· Register map detailed explanation (continued)

<b>S</b>	h Address		DATA										
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0				
	Data Name	_	_	_	_	_	_	_	MTXON				
20h	Default	0	0	0	0	0	0	0	0				
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R				

D0 : MTXON ON/OFF setup of matrix LED

[0] : OFF (default)

[1] : ON

- During MTXON = "1", subsequent ROM, RAM, and the control contents to a register are sequentially processed and lit up.
- Wait 5 ms when MTXON is set to "1" after address 01h OSCEN is set to "1".
- Set MTXON to "1", and then set up other addresses to display the matrix part.

<b>6</b>	b Address		DATA									
Su	D Address	D7	D6	D5	D4	D3	D2	D1	D0			
	Data Name		MTXDATA[7:0]									
21h	Default	0	0	0	0	0	0	0	0			
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R			

D7-0 : MTXDATA[7:0] Address setup of ROM/RAM of the data to read

[00000000] - [10010101] : ROM ( Only luminosity )

7×7 pattern No.0 (default) to No.149

[10010110] - [11010000] : ROM (Luminosity + Cycle + Delay)

7×7 pattern No. 150 to No.208

[11010001] : RAM (Luminosity + Cycle + Delay)

7×7 pattern RAM No.1

[11010010] : RAM (Luminosity + Cycle + Delay)

7×7 pattern RAM No.2

• The pattern No.0 of ROM is all "0" data of matrix LED.

· Accessing to 21h is disabled while copying from ROM to RAM (COPYSTART 24h = "1").



#### 4. Register and Address (continued)

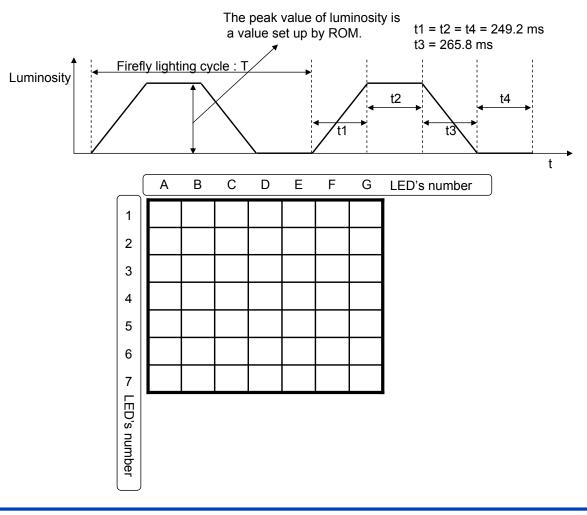
Register map detailed explanation (continued)

	h Address		DATA										
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0				
	Data Name	_	—	—	_	_	_	ROM7	77[1:0]				
22h	Default	0	0	0	0	0	0	0	0				
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R				

D1-0 : ROM77[1:0] Lighting control of the 7×7 (LED No.A1-G7) fixed pattern of ROM

- [00] : ROM data is displayed.
- [01] : ROM data is displayed by firefly lighting in 1 s.
- [10] : ROM data is displayed by firefly lighting in 2 s.
- [11] : ROM data is displayed by firefly lighting in 3 s

• During display of repetition (REPON = "1"), ROM77 must not be changed.





#### 4. Register and Address (continued)

· Register map detailed explanation (continued)

0						DATA			
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0
	Data Name SELROM[7:0]								
23h	Default	0	0	0	0	0	0	0	0
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R

D7-0 : SELROM[7:0] Address setup of ROM copied to RAM

[00000000] - [10010101] : ROM (Only luminosity) 7×7 pattern No.0 (default) to No.149

[10010110] - [11010000] : ROM (Luminosity + Cycle + Delay) 7×7 pattern No.150 to No.208

• Accessing to 23h is disabled while copying from ROM to RAM (COPYSTART 24h = "1").

<b>e</b>	b Address					DATA			
Su		D7	D6	D5	D4	D3	D2	D1	D0
	Data Name			—				SELRAM	COPYSTART
24h	Default	0	0	0	0	0	0	0	0
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R

D1 : SELRAM RAM number setup of a copy place.

[0] : RAM No.1

[1] : RAM No.2

D0 : COPYSTART Copy start ON/OFF control to RAM from ROM

[0] : OFF

[1] : The copy set up by SELROM and SELRAM is started. (It returns to 0 by internal 51 CLK.)

- Address 24h is only for copying data to RAM and never start LED display. (However, if this RAM is copied when LED display is showing, LED display is updated.)
- Writing in address 21h-MTXDATA, 2Ah-SCLON, and 27h-REPON is disabled while copying. (RAMACT flag is raised.)
- · Accessing to SELRAM is disabled while copying from ROM to RAM (COPYSTART 24h = "1")
- Don't write address 29h (RAM-clear ) while copying.

(The waiting time for over 1 ms is required after COPYSTART.)



#### 4. Register and Address (continued)

· Register map detailed explanation (continued)

<b>C</b>	h Addroop				DA	TA			
Sui	b Address	D7	D6	D5	D4	D3	D2	D1	D0
	Data Name				SETFR	OM[7:0]			
25h	Default	0	0	0	0	0	0	0	0
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R

D7-0 : SETFROM[7:0] An address setup of the ROM frame data at the repetition display start. [0000000] - [10010101] : ROM (Only luminosity) 7×7 pattern No.0 (default) to No.149 [10010110] - [11010000] : ROM (Luminosity + Cycle + Delay) 7×7 pattern No.150 to No.208

• During display of repetition (REPON = "1"), Don't change the setting of SETFROM.

<b>C</b>	h Address		DATA										
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0				
	Data Name				SETT	O[7:0]							
26h	Default	0	0	0	0	0	0	0	0				
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R				

D7-0 : SETTO[7:0] Address setup of the ROM frame data at the repetition display end [00000000] - [10010101] : ROM (Only luminosity) 7×7 pattern No.0 (default) to No.149 [10010110] - [11010000] : ROM (Luminosity + Cycle + Delay) 7×7 pattern No.150 to No.208

• During display of repetition (REPON = "1"), don't change the setting of SETTO.



#### 4. Register and Address (continued)

· Register map detailed explanation (continued)

<b></b>	h Addroop				DA	TA			
Sub Address		D7	D6	D5	D4	D3	D2	D1	D0
	Data Name	_	_	_	_	_	_	_	REPON
27h	Default	0	0	0	0	0	0	0	0
	mode	W/R							

D0 : REPON Repetition display ON/OFF control

- [0] : Repetition display OFF (default)
- [1] : Repetition display ON
- During display of repetition, display of set-up ROM is continued.
- A repetition display is started in the state of MTXON = "1" and REPON = "1".
- · Accessing to 27h is disabled while copying from ROM to RAM (COPYSTART 24h = "1").
- When the setting of SCLON is changed from Low to High while REPON = "1", REPON becomes "0" and it shifts to scroll function.
- During display of repetition (REPON = "1"), don't change the setting of SETFROM and SETTO.

- Cul	h Address		DATA											
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0					
	Data Name	_	_		_			SETTI	ME[1:0]					
28h	Default	0	0	0	0	0	0	0	0					
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R					

D1-0 : SETTIME[1:0] A frame display time setup of repetition display

[00] : 1 s (default)

[01] : 2 s

[10] : 3 s

[11] : 4 s



#### 4. Register and Address (continued)

Register map detailed explanation (continued)

<b>S</b>	h Address		DATA										
Su	b Address	D7	D6	D5	D4	D3	D2	D1	D0				
	Data Name	_		_				RAM1	RAM2				
29h	Default	0	0	0	0	0	0	0	0				
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R				

D1 : RAM1 The data in  $7 \times 7$  RAM1 is cleared.

0 : Overwrite is possible. (default)

1 : The data in 7×7 RAM1 is cleared. (It returns to 0 by internal 2 CLK.)

D0 : RAM2 The data in 7×7 RAM2 is cleared.

- 0 : Overwrite is possible. (default)
- 1 : The data in  $7 \times 7$  RAM2 is cleared. (It returns to 0 by internal 2 CLK.)
- Don't set the RAM-clear operation for RAM1 or RAM2 during display of repetition (SCLON = "1").
- Don't set the RAM-clear operation (29h) during the COPY operation (24h).

(The waiting time for over 1 ms is required after COPYSTART.)



#### 4. Register and Address (continued)

Register map detailed explanation (continued)

S	b Address		DATA										
Su	D AUUIESS	D7	D6	D5	D4	D3	D2	D1	D0				
	Data Name	_	_	_	_	_	—	_	SCLON				
2Ah	Default	0	0	0	0	0	0	0	0				
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R				

D0 : SCLON ON/OFF setup of scroll display

[0] : OFF (default)

[1] : ON

- The scroll display displays the data which exists in the RAM No.1-2 of 7×7 in order of A-G column. The display travel time of a column is the preset value of SCLTIME.
- During display of scroll, data can be written to RAM without specifying RAM number. (Writing is performed to empty RAM.)
- The scroll display is started in the state of MTXON = "1" and SCLON.
- Accessing to 2Ah is disabled while copying from ROM to RAM (COPYSTART 24h = "1").
- When the setting of REPON is changed from "0" to "1" while SCLON = "1", SCLON becomes "0" and it shifts to repetition display function.
- During display of scroll (SCLON = "1"), don't change the setting of RAM1 and RAM2.
- Once the scroll function was set, then the SCLON = "0" or MTXON = "0", RSTB terminal must be "L" to reset before the scroll function is set again.

<b></b>	b Address		DATA										
Su	D Address	D7	D6	D5	D4	D3	D2	D1	D0				
	Data Name	_	—	_	_	_	_	SCLTI	ME[1:0]				
2Bh	Default	0	0	0	0	0	0	0	0				
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R				

D1-0 : SCLTIME[1:0] Frame display time setup of scroll display

[00] : 0.1 s (default)

[01] : 0.2 s

[10] : 0.4 s

[11]: 0.8 s

· The display travel time of the column is the preset value of SCLTIME.



### 4. Register and Address (continued)

Register map detailed explanation (continued)

Sub Address			DATA									
		D7	D6	D5	D4	D3	D2	D1	D0			
	Data Name	_	—	_	_	_	_	_	RGBON			
2Ch	Default	0	0	0	0	0	0	0	0			
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R			

D0 : RGBON ON/OFF setup of RGB lighting

[0] : OFF (default)

[1] : ON

• Wait 5 ms when RGBON is set to "1" after address 01h OSCEN is set to "1".

Sub Address		DATA								
		D7	D6	D5	D4	D3	D2	D1	D0	
	Data Name	—	_	RGBDATA[5:0]						
2Dh	Default	0	0	0	0	0	0	0	0	
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R	

D7-0 : RGBDATA[5:0] Address setup of ROM and register which read RGB data [000000] : Register is displayed.

[000001] - [101010] : ROM (RGB pattern, Luminosity + Cycle + Delay) pattern No.1 to No.42

Sub Address		DATA									
		D7	D6	D5	D4	D3	D2	D1	D0		
	Data Name		For test								
2Eh	Default	0	0	0	0	0	0	0	0		
	mode	R	R	R	R	R	R	R	R		

\*Don't access to address 2Eh.



#### 4. Register and Address (continued)

Register map detailed explanation (continued)

Sub Address			DATA									
		D7	D6	D5	D4	D3	D2	D1	D0			
30h	Data Name	_	_	_	_	_	_	_	RAMNUM			
	Default	0	0	0	0	0	0	0	0			
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R			

D1-0 : RAMNUM[1:0] RAM number setup at the CPU access (READ and WRITE).

[0] : RAM No.1

[1] : RAM No.2

Accessing to 30h is disabled during display of scroll (2Ah SCLON = "1").



#### 4. Register and Address (continued)

Register map detailed explanation (continued)

Sub Address		DATA								
		D7	D6	D5	D4	D3	D2	D1	D0	
	Data Name		BLA	1[3:0]		FRA	1[1:0]	DLA1[1:0]		
31h	Default	0	0	0	0	0	0	0	0	
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R	

D7-4 : BLA1[1:0] Luminosity setup of LED No.A1
[0000] : 0 mA (default)
[0001] : 1 mA
[0010] : 2 mA
[0011] : 3 mA
[0100] : 4 mA
[0101] : 5 mA
[0110] : 8 mA
[0111] : 11 mA
[1000] : 15 mA
[1001] : 17 mA
[1010] : 19 mA
[1011] : 21 mA
[1100] : 24 mA
[1101] : 26 mA
[1110] : 28 mA

	Α	В	С	D	Е	F	G	LED's number
1								
2								
3								
4								
5								
6								
7								
LED's number								

D3-2 : FRA1[1:0] Firefly operation and cycle setup of the LED No.A1

- [00] : Lighting mode (default)
- [01] : Firefly lighting cycle 1 s
- [10] : Firefly lighting cycle 2 s
- [11] : Firefly lighting cycle 3 s

D1-0 : DLA1[1:0] Firefly operation delay setup of the LED No.A1

- [00] : No delay (default)
- [01] : Delay 25%

[1111] : 30 mA

- [10] : Delay 50%
- [11] : Delay 75%
- The operation is the same as above for the addresses to 61h corresponding to each LED number.
- The waiting time for 2 or more internal clocks (2 μs or more) is required after the data from address 31h to 61h is written in. Please input other serial commands after that.



#### 4. Register and Address (continued)

#### Register map detailed explanation (continued)

Sub Address		DATA								
		D7	D6	D5	D4	D3	D2	D1	D0	
	Data Name		BLLED	DR[3:0]		FRLED	DR[1:0]	DLLEDR[1:0]		
62h	Default	0	0	0	0	0	0	0	0	
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R	

D7-4 : BLLEDR1[1:0] Luminosity setup of R1 terminal

[0000] : 0 mA (default) [0001] : 1 mA [0010] : 2 mA : : [1110] : 14 mA [1111] : 15 mA

D3-2 : FRLEDR1[1:0] Firefly operation and cycle setup of R1 terminal

[00] : Lighting mode (default)

[01] : Firefly lighting cycle 1 s

[10] : Firefly lighting cycle 2 s

[11] : Firefly lighting cycle 3 s

D1-0 : DLLEDR1[1:0] Firefly operation delay setup of R1 terminal

[00] : No delay (default)

[01] : Delay 25%

[10] : Delay 50%

[11] : Delay 75%

• The operation is the same as above for the addresses to 64h corresponding to G and B terminal.

 The waiting time for 2 or more internal clocks (2 μs or more) is required after the data from address 62h to 64h is written in. Please input other serial commands after that.



#### 4. Register and Address (continued)

Register map detailed explanation (continued)

Sub Address		DATA									
		D7	D6	D5	D4	D3	D2	D1	D0		
	Data Name		For test								
6Bh	Default	0	0	0	0	0	0	0	0		
	mode	W/R	W/R	W/R	W/R	W/R	W/R	W/R	W/R		

\*Address from 6Bh onwards are registers for test. Don't write into these addresses.



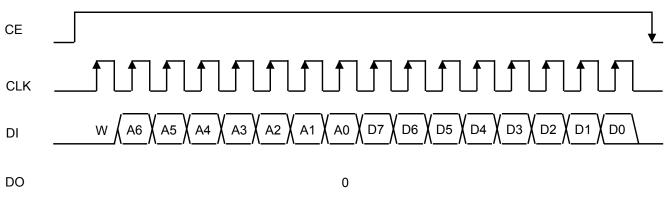
#### 5. Serial interface format

- SPI format
- The interface with microcomputer consists of 16 bit-serial register (8-bit of command, 8-bit of address), and address decoder and transmitting register (8-bit).
- Serial interface consists of four terminals of serial clock terminal (CLK), serial-data input terminal (DI), serial-data output terminal (DO), and chip enable input terminal (CE).

(1) Write operation

- Data is taken into internal shift register by the rising edge of CLK. (Maximum 13 MHz of frequency of CLK can be used)
- Serial interface consists of four terminals of serial clock terminal (CLK), serial-data input terminal (DI), serialdata output terminal (DO), and chip enable input terminal (CE).
- Data is transmitted at MSB first in order of a control register address (8-bit) and control command (8-bit).

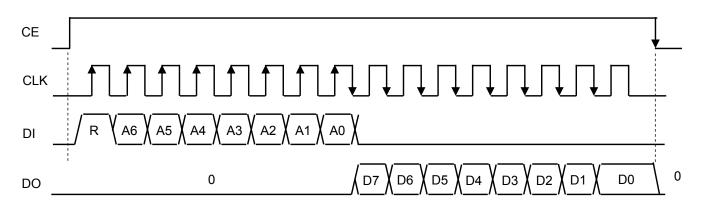
## Write access Timing



#### (2) Transmission operation

- Data is taken into internal shift register by the rising edge of CLK. (A maximum of 6 MHz of frequency of CLK can be used)
- It is not possible to read RAM data.
- In High interval of CE, reception of data becomes ENABLE. (active : High)
- Data is transmitted at MSB first in order of a control register address (8-bit) and control command (max 8-bit).

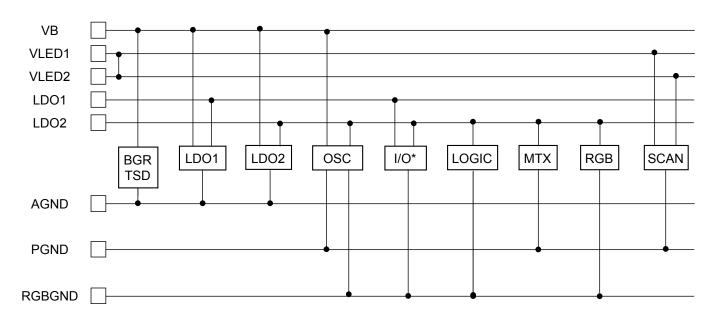
#### Read access Timing





#### 6. Signal distribution diagram

Power supply distribution diagram

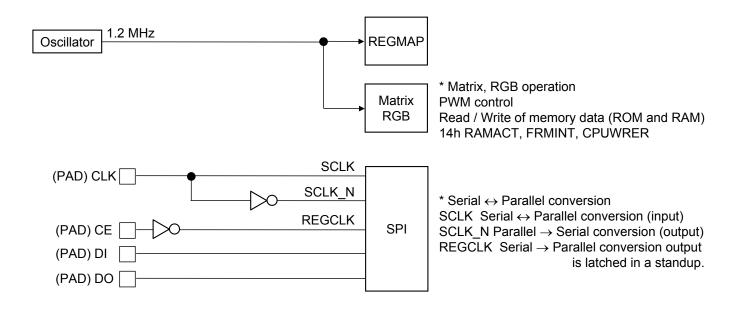


<sup>\*</sup>CLK, CE, DI, DO, LEDCTL



#### 6. Signal distribution diagram (continued)

Control / Clock distribution diagram

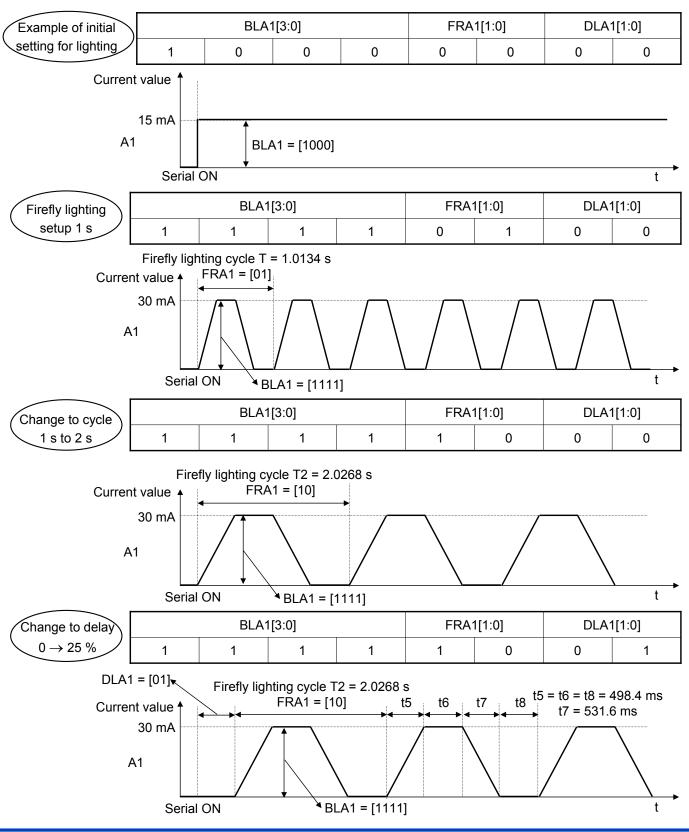


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## **OPERATION** (continued)

### 7. Example of firefly lighting

Example of firefly lighting 1

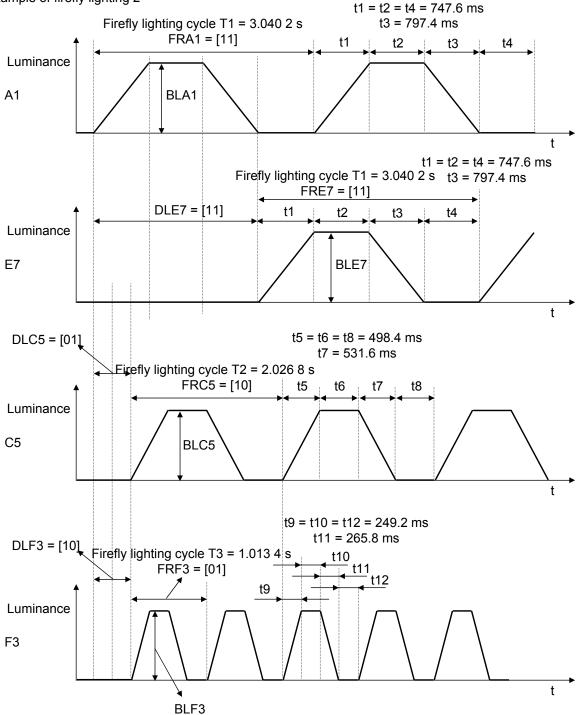


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## **OPERATION** (continued)

### 7. Example of firefly lighting (continued)

• Example of firefly lighting 2

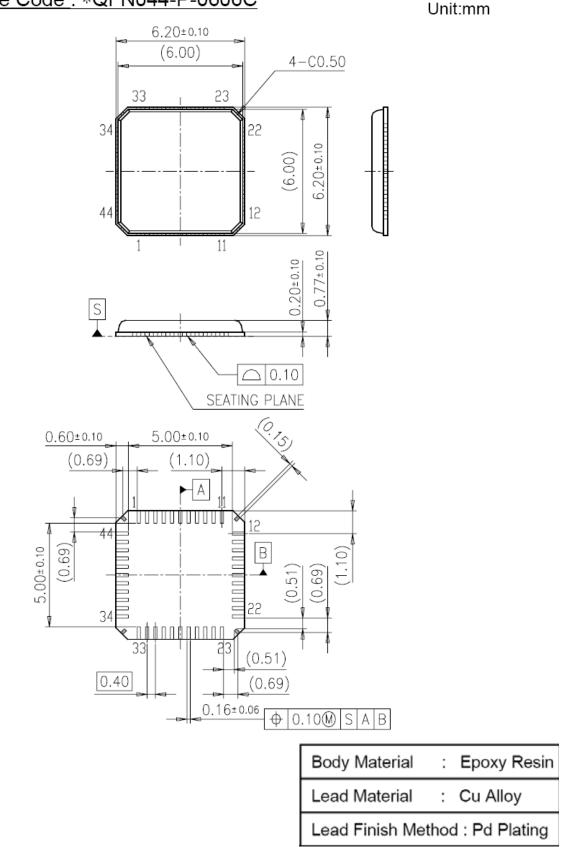


- 1. Normally, it is not possible to control data when RGBGND pin voltage is undefined. Therefore, please keep the RGBGND pin voltage at the lowest voltage.
- 2. Please check the input waveform to the CLK pin. When inputting clock into the CLK pin, if the input clock is ringing with input voltage between 0.4 V to LDO1 × 0.8 V (input voltage indefinite range), it will result in serial data not able to be written to or be read out from a register. (It is recommended to smooth the rising and falling edge of the input clock by connecting input capacitance (a capacitor, etc.) to the CLK pin.)



## PACKAGE INFORMATION (Reference Data)

## Package Code : \*QFN044-P-0606C



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- The protection circuit is for maintaining safety against abnormal operation. Therefore, the protection circuit should not work during normal operation.
   Especially for the thermal protection circuit, if the area of safe operation or the absolute maximum rating is momentarily exceeded due to output pin to VCC short (Power supply fault) or output pin to CND short (Ground fault), the LSL might be
- exceeded due to output pin to VCC short (Power supply fault), or output pin to GND short (Ground fault), the LSI might be damaged before the thermal protection circuit could operate.11. Unless specified in the product specifications, make sure that negative voltage or excessive voltage are not applied to the
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